

SANYO Semiconductors DATA SHEET

TT2274T ____ NPN Triple Diffused Planar Silicon Transistor

Switching Regulator Applications

Features

- High breakdown voltage (VCBO≥1400V).
- · Ultrahigh-speed switching.
- Wide ASO.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		1400	٧
Collector-to-Emitter Voltage	VCEO		800	٧
Emitter-to-Base Voltage	V _{EBO}		5	٧
Collector Current	IC		1	Α
Collector Current (Pulse)	ICP	PW≤300μs, duty cycle≤10%	2	Α
Collector Dissipation	PC		1	W
	10	Tc=25°C	25	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Collector Cutoff Current	ІСВО	V _{CB} =800V, I _E =0A			10	μΑ
Collector Cutoff Current	ICES	V_{CB} =1400V, R_{BE} =0 Ω			1	mA
Emitter Cutoff Current	IEBO	VEB=4V, IC=0A			1	mA
DC Current Gain	hFE1	V _{CE} =5V, I _C =0.1A	15		35	
	hFE2	V _{CE} =5V, I _C =0.5A	4			

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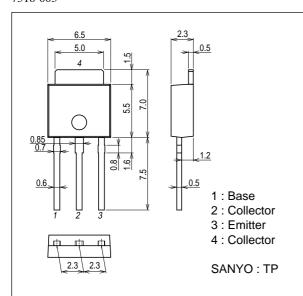
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Collector-to-Emitter Saturation Voltage	VCE(sat)	IC=0.25A, IB=0.05A			1.5	٧
Base-to-Emitter Saturation Voltage	V _{BE} (sat)	I _C =0.5A, I _B =0.1A			1.5	V
Collector-to-Base Breakdown Voltage	V(BR)CBO	IC=1mA, IE=0A	1400			٧
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=5mA, RBE=∞	800			V
Emitter-to-Base Breakdown Voltage	V _{(BR)EBO}	IE=1mA, IC=0A	5			V
Storage Time	tstg	IC=0.5A, IB1=0.1A, IB2=-0.25A, RL=400Ω, VCC=200V		1.5	3.0	μS
Fall Time	tf	I _C =0.5A, I _B 1=0.1A, I _B 2=-0.25A, R _L =400Ω, V _{CC} =200V		0.25	0.4	μS

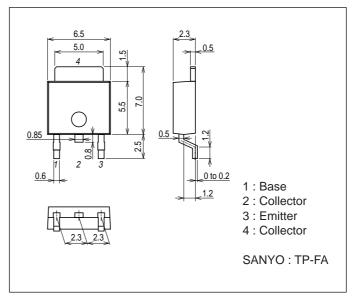
Package Dimensions

unit : mm (typ) 7518-003

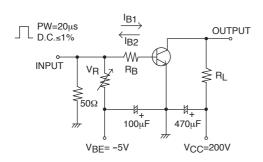


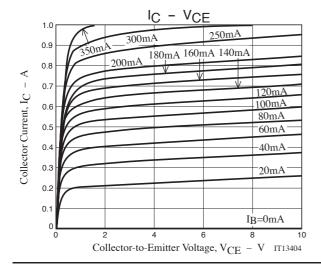
Package Dimensions

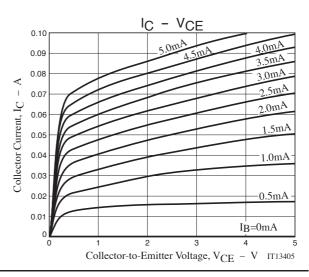
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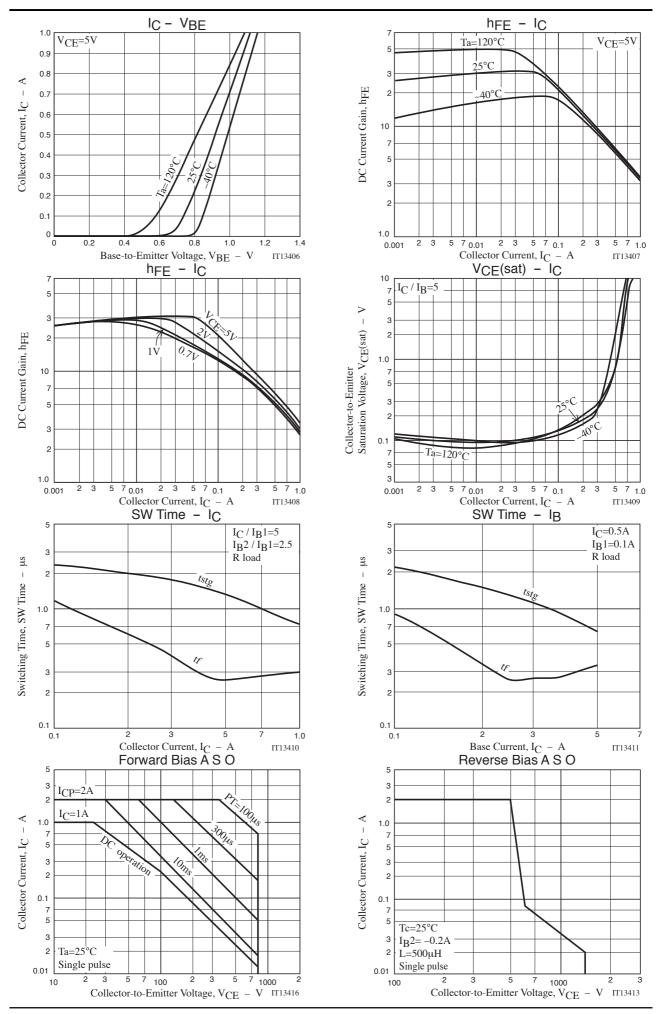


Switching Time Test Circuit

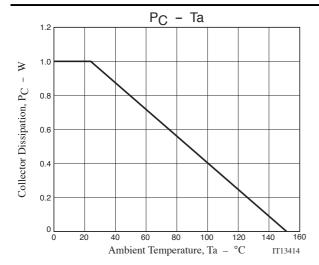


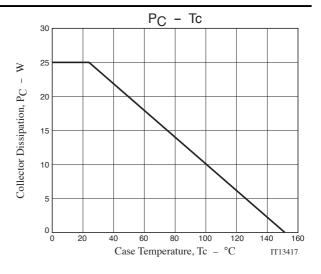






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